

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

lőplicants:

H. MATSUURA, et al.

Serial No.:

10/519,713

Filed:

DECEMBER 30, 2004

Title:

ADHESIVE FILM FOR SEMICONDUCTOR USE, METAL SHEET LAMINATED WITH ADHESIVE FILM, WIRING CIRCUIT LAMINATED WITH ADHESIVE FILM, AND

SEMICONDUCTOR

Group AU:

2823

Examiner:

Julio J. Maldonado

Confirm. No:

7508

RESPONSE

Mail Stop: AMEND - NO FEE Commissioner for Patents P.O. Box 1450 Alexandria, Virginia 22313-1450

August 25, 2006

Sir:

In response to the Office Action mailed July 27, 2006, Applicants respectfully elect the Group II claims, that is, claims 19 and 20, drawn to a method of manufacturing a semiconductor device, this election being made without traverse.

Examination of the Group II claims, on the merits, in due course, is respectfully requested.

Please charge any shortage of fees due in connection with the filing of this paper to the Deposit Account of Antonelli, Terry, Stout & Kraus, LLP, Deposit Account No. 01-2135 (case No. 1204.44601X00), and credit any excess fees paid to such Deposit Account.

Respectfully submitted,

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